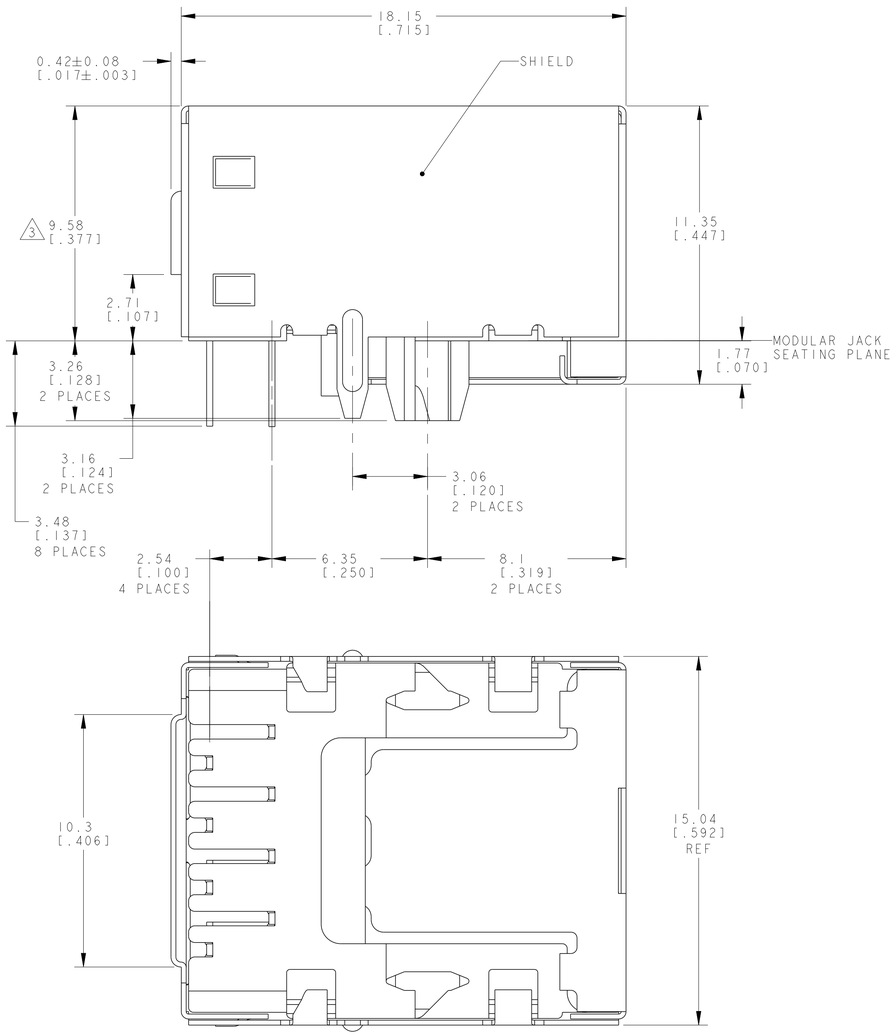
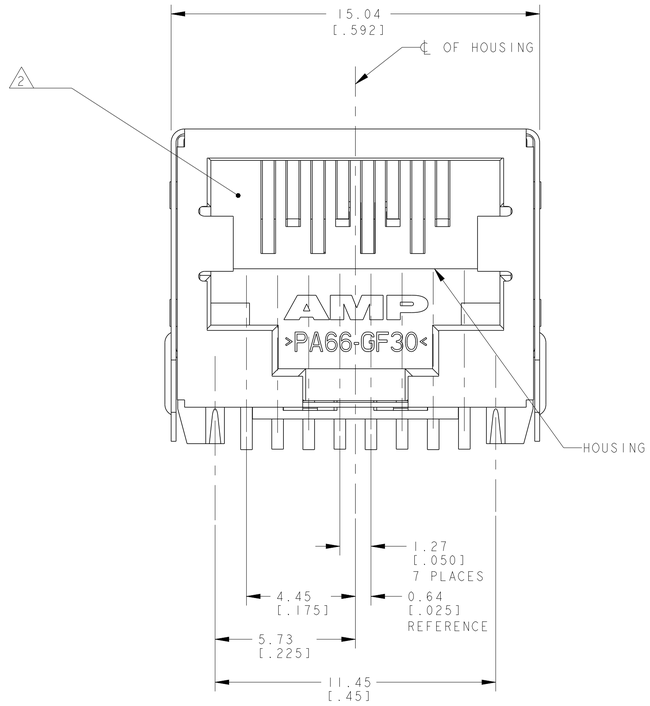
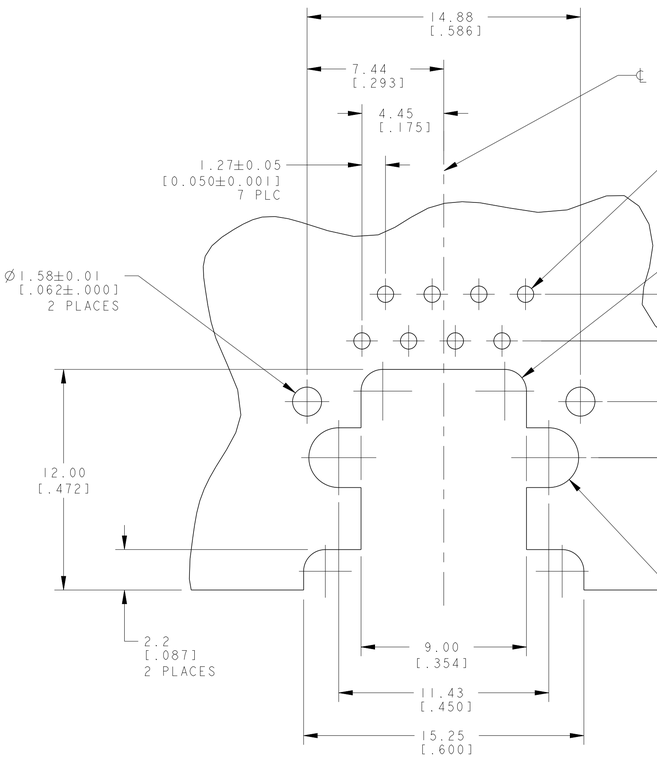
REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
	B	REVISE PER ECO-14-015233	31MAR2015	LL	SH
	B1	MODIFIED AS PER ECR-23-169440	05APR2023	KV	WH







SUGGESTED PRINTED CIRCUIT
BOARD LAYOUT
COMPONENT SIDE
SCALE 6:1

1. MATERIAL: HOUSING - HIGH TEMPERATURE NYLON,BLACK, UL 94V-0,
IR REFLOW SOLDERING PROCESS COMPATIBLE
TERMINALS - 0.25[.01] THICK PHOSPHOR BRONZE PLATED WITH
3.81µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA
AREA, 1.27µm[.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA.
ENTIRE TERMINAL PLATED WITH 1.27µm[.000050] MINIMUM THICK
NICKEL.
SHIELD - 0.11[.0039] MIN THICK COPPER ZINC ALLOY, PREPLATED WITH 1.27um(0.000050)min
THICK NICKEL AND HOT TIN DIP ON PCB GROUND TABS.

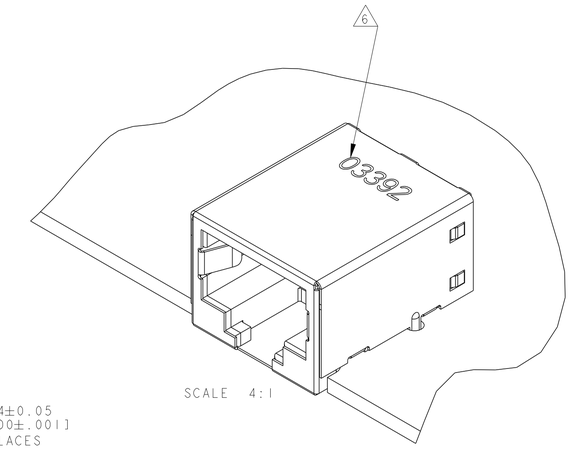
2 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68,
SUBPART F.

3 THIS DIMENSION REPRESENTS THE TOTAL HEIGHT OF THE CONNECTOR
FROM THE TOP OF THE PC BOARD.

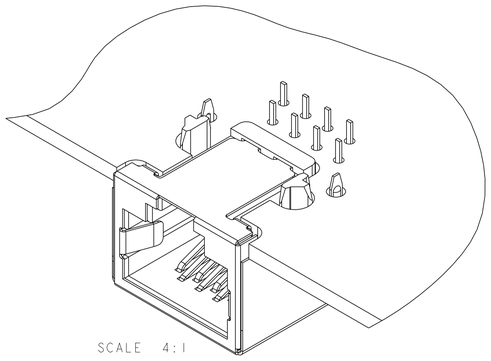
4. PACKAGED 66 ASSEMBLIES PER PVC TRAY, 396 PER BOX.

5. DIELECTRIC WITHSTANDING VOLTAGE BETWEEN SHIELD AND
TERMINAL IS 1500 VAC

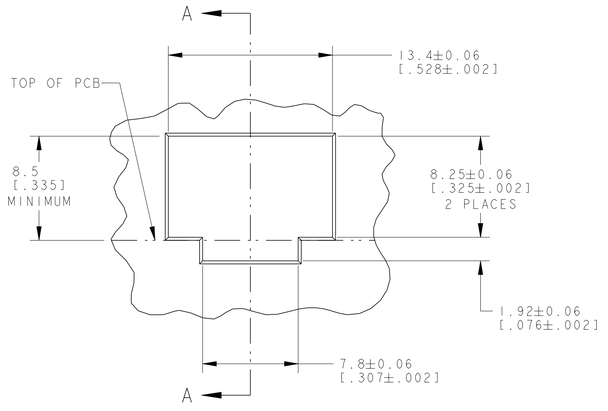
6 MANUFACTURING DATE CODE:
ORIENTED AND LOCATED APPROXIMATELY AS SHOWN. LASER PRINTING.
TEXT HEIGHT APPROXIMATELY 2MM.
FIRST 2 DIGITS = LAST 2 DIGITS OF YEAR
NEXT 2 DIGITS = MANUFACTURING WORK WEEK
LAST DIGIT = DAY OF WEEK WITH SUNDAY = 1



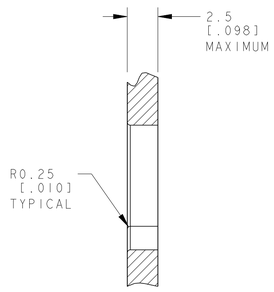
SCALE 4:1



SCALE 4:1



SUGGESTED PANEL CUTOUT
SCALE 4:1



SECTION A-A

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN 07JUNE2006 J. AHERON/L.A.MAYER	TE Connectivity
DIMENSIONS: mm[INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ±- 1 PLC ±- 2 PLC ±0.13[.005] 3 PLC ±- 4 PLC ±- ANGLES ±-	CHK 07JUNE2006 J.WESTMAN	NAME MODULAR JACK ASSEMBLY, 8 POSITION, SHIELDED, 10mm WITHOUT PANEL TABS
		APVD 07JUNE2006 S.FLICKINGER	PRODUCT SPEC 108-1163
			APPLICATION SPEC 114-2048
MATERIAL SEE NOTE 1	FINISH SEE NOTE 1	WEIGHT 3.49 grams	SIZE A1 CAGE CODE - DRAWING NO C-1888543 RESTRICTED TO
		CUSTOMER DRAWING	SCALE 4:1 SHEET 1 OF 1 REV B1

1888543-2
PART NUMBER